### TOSHIBA

#### TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

### TC7MBL6353SFT,TC7MBL6353SFK,TC7MBL6353SFTG

Low Voltage/Low Capacitance Dual 1-of-2 Multiplexer/Demultiplexer

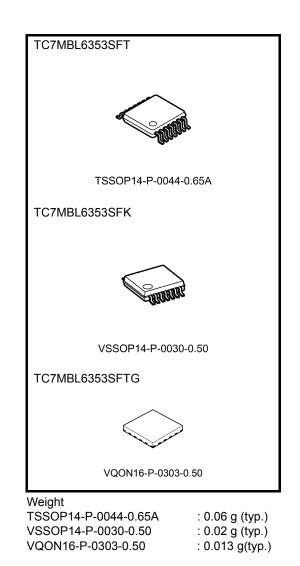
The TC7MBL6353S is a Low Voltage/Low Capacitance CMOS Dual 1-of-2 Multiplexer/Demultiplexer. The low on-resistance of the switch allows connections to be made with minimal propagation delay time.

This device consists of two individual two-inputs multiplexer/ demultiplexer with common select input (S) and output enable ( $\overline{OE}$ ). The A input is connected to the B1 or B2 outputs as determined by the combination of both the select input (S) and output enable ( $\overline{OE}$ ). When the output enable ( $\overline{OE}$ ) input is held at "H" level, the switches are open regardless of the state of the select inputs, and a high-impedance state exists between the switches.

All inputs are equipped with protection circuits against static discharge.

#### Features

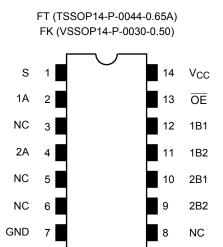
- Operating voltage:  $V_{CC} = 1.65$  to 3.6 V
- Low capacitance:  $C_{I/O} = 15 \text{ pF}$  Switch On (typ.) @3 V
- Low on-resistance:  $R_{ON} = 9 \Omega$  (typ.) @3 V
- ESD performance: Machine model  $\ge \pm 200 \text{ V}$ Human body model  $\ge \pm 2000 \text{ V}$
- Power-down protection for inputs ( $\overline{\mathsf{OE}}$  input only)
- Package: TSSOP14,VSSOP (US14), VQON16



Note: When mounting VQON package, the type of recommended flux is RA or RMA.

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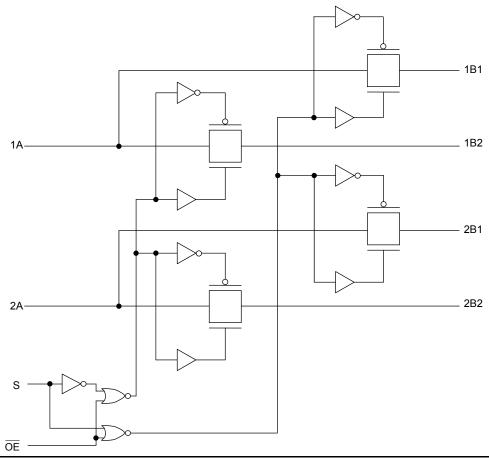
### Pin Assignment (top view)



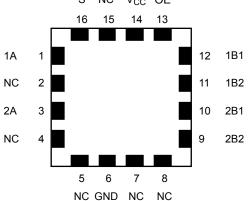
### **Truth Table**

Inp	outs	Function		
S	ŌĒ	runcion		
Х	Н	Disconnect		
L	L	nA port = nB1 port		
Н	L	nA port = nB2 port		

### System Diagram



### S NC $V_{CC}$ $\overline{OE}$



FTG (VQON16-P-0303-0.50)

#### **Absolute Maximum Ratings (Note)**

Characteristic		Symbol	Rating	Unit
Power supply range		V <sub>CC</sub>	-0.5 to 4.6	V
Control pin input v	oltage	VIN	-0.5 to 4.6	V
Switch terminal I/O voltage		VS	$-0.5$ to $V_{CC}$ + 0.5	V
Clump diode	Control input pin	lu c	-50	mA
current	Switch terminal	lік	±50	mA
Switch I/O current		IS	50	mA
Power dissipation		PD	180	mW
DC V <sub>CC</sub> /GND current		I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature		T <sub>stg</sub>	–65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Operating Ranges (Note)**

Characteristic	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	1.65 to 3.6	V
Control pin input voltage	V <sub>IN</sub>	0 to 3.6	V
Switch I/O voltage	VS	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

### **Electrical Characteristics**

### DC Characteristics (Ta = -40 to 85°C)

Parame	Parameter		Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Input voltage	"H" level	VIH	_	1.65 to 3.6	$0.7 \times V_{CC}$	_	_	V
input voltage	"L" level	V <sub>IL</sub>	_	1.65 to 3.6	_	_	$0.3 \times V_{CC}$	v
Input leakage cur	rent ( OE , S)	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6V	1.65 to 3.6	_	_	±1.0	μA
Power-off leakage	e current	IOFF	$\overline{OE} = 0$ to 3.6 V	0	—	_	1.0	μA
Off-state leakage (switch off)	current	I <sub>SZ</sub>	A, B = 0 to V <sub>CC</sub> , $\overline{OE} = V_{CC}$	1.65 to 3.6	_	_	±1.0	μΑ
On resistance (Note2)			$V_{IS} = 0 V, I_{IS} = 30 mA$ (Note1)	3.0		9	13	
			$V_{IS} = 3.0 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note1)	3.0		15	20	
		Davi	$V_{IS} = 2.4 \text{ V}, I_{IS} = 15 \text{ mA}$ (Note1)	3.0	_	19	27	Ω
		R <sub>ON</sub>	$V_{IS} = 0 V, I_{IS} = 24 mA$ (Note1)	2.3	_	10	16	52
			$V_{IS} = 2.3 \text{ V}, I_{IS} = 24 \text{ mA}$ (Note1)	2.3	_	17	24	
			$V_{IS} = 2.0 \text{ V}, I_{IS} = 15 \text{ mA}$ (Note1)	2.3	_	21	30	
Quiescent supply	current	ICC	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	3.6			10	μA

Note1: All typical values are at Ta=25°C.

Note2: Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

### AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation dolay time	+		3.3 ± 0.3	_	6	
Propagation delay time (S to bus)	t <sub>pLH</sub>	Figure 1, Figure 2	$2.5\pm0.2$		7	ns
(3 to bus)	t <sub>pHL</sub>		$1.8\pm0.15$	_	11	
Output anabla time			$\textbf{3.3}\pm\textbf{0.3}$		6	
Output enable time $(\overline{OE} \text{ to bus})$	t <sub>pZL</sub>	Figure 1, Figure 3	$2.5\pm0.2$		7	ns
	t <sub>pZH</sub>		$1.8\pm0.15$		11	
Output anable time	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 3	$\textbf{3.3}\pm\textbf{0.3}$	_	6	ns
Output enable time (S to bus)			$2.5\pm0.2$	_	7	
(0 10 003)			$1.8\pm0.15$		11	
Output disable time	t <sub>pLZ</sub> t <sub>pHZ</sub>	Figure 1, Figure 3	$\textbf{3.3}\pm\textbf{0.3}$		6	
Output disable time ( OE to bus)			$2.5\pm0.2$		7	ns
			$1.8\pm0.15$		11	
Output disable time	t <sub>pLZ</sub>		$\textbf{3.3}\pm\textbf{0.3}$		6	
(S to bus)	τ <sub>pHZ</sub>	Figure 1, Figure 3	$\textbf{2.5}\pm\textbf{0.2}$	_	7	ns
	ΨΠΖ		$1.8\pm0.15$		11	

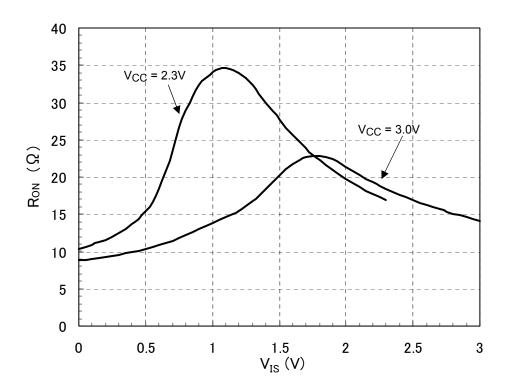
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### **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Control pin input capacitance ( $\overline{\text{OE}}$ , S)	C <sub>IN</sub>		3.0	3	pF
Switch terminal capacitance (B1, B2)	C <sub>I/O</sub>	$\overline{OE} = V_{CC}$ (switch off)	3.0	6	pF
Switch terminal capacitance (A)	C <sub>I/O</sub>	$\overline{OE} = V_{CC}$ (switch off)	3.0	9	pF
Switch terminal capacitance	C <sub>I/O</sub>	$\overline{OE}$ = GND (switch on)	3.0	15	pF

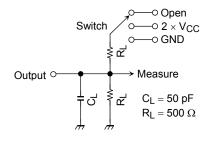
Note: This parameter is guaranteed by design

### • R<sub>ON</sub> Characteristic (typ.) Ta=25°C



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### **AC Test Circuit**



Parameter	Switch
t <sub>pLH</sub> , t <sub>pHL</sub>	Open
t <sub>pLZ</sub> , t <sub>pZL</sub>	$2 \times V_{CC}$
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND

Figure 1

### AC Waveform

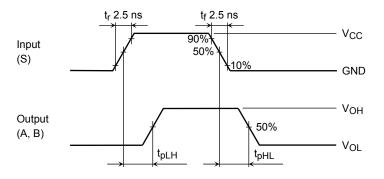
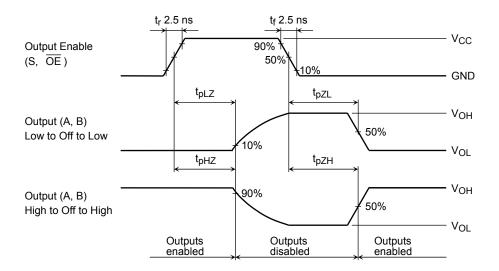
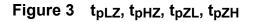


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>





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### Rise and Fall Times (tr / tf) of the TC7MBL6353S I/O Signals

The tr(out) and tf(out) values of the output signals are affected by the CR time constant of the input, which consists of the switch terminal capacitance ( $C_{I/O}$ ) and the on-resistance ( $R_{ON}$ ) of the input.

In practice, the tr(out) and tf(out) values are also affected by the circuit's capacitance and resistance components other than those of the TC7MBL6353S.

The tr(out) / tf(out) values can be approximated as follows. (Figure 4 shows the test circuit.)

 $tr(out) / tf(out) (approx) = - (C_{I/O} + C_L) \cdot (R_{DRIVE+} R_{ON}) \cdot ln (((V_{OH} - V_{OL}) - V_M) / (V_{OH} - V_{OL}))$ 

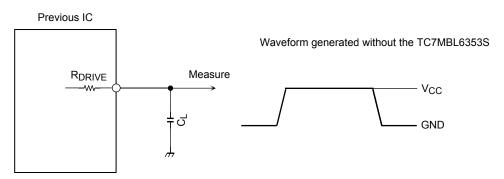
where,  $R_{DRIVE}$  is the output impedance of the previous-stage circuit.

Calculation example:

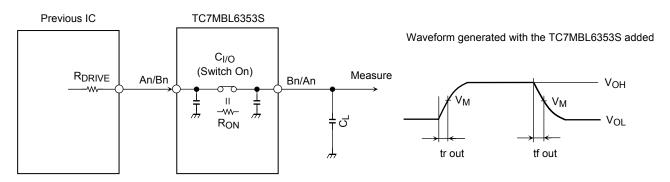
tr(out) (approx) = - ( 15 + 15 )E-12 · ( 120 + 9) · ln ( ( ( 3.0 - 0 ) - 1.5 ) / ( 3.0 - 0 ) )  $\approx 2.7$  ns

Calculation conditions:

 $V_{CC}$  = 3.0V ,  $C_L$  = 15pF ,  $R_{DRIVE}$  = 120 $\Omega$ (output impedance of the previous IC),  $V_M$  = 1.5V ( $V_{CC}$  / 2) Output of the previous IC = digital (i.e., high-level voltage =  $V_{CC}$ ; low-level voltage = GND)



R<sub>DRIVE</sub> = output impedance of the previous IC



R<sub>DRIVE</sub> = output impedance of the previous IC

Parameter	V <sub>CC</sub>					
Farameter	3.3 ± 0.3 V	2.5 ± 0.2 V	1.8 ± 0.15 V			
VM	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2			

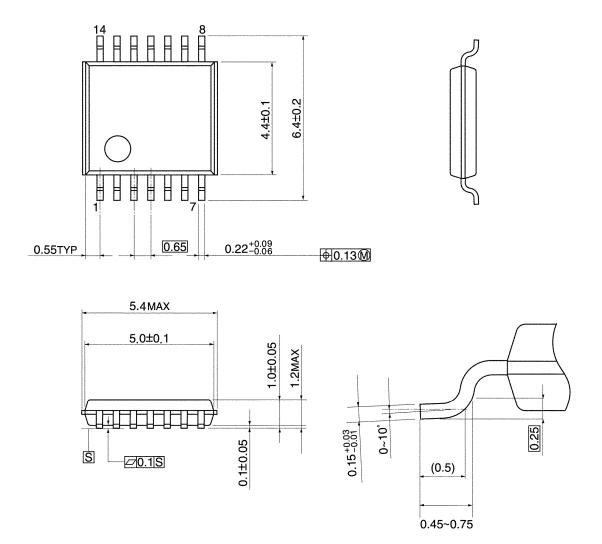




### **Package Dimensions**

TSSOP14-P-0044-0.65A

Unit: mm



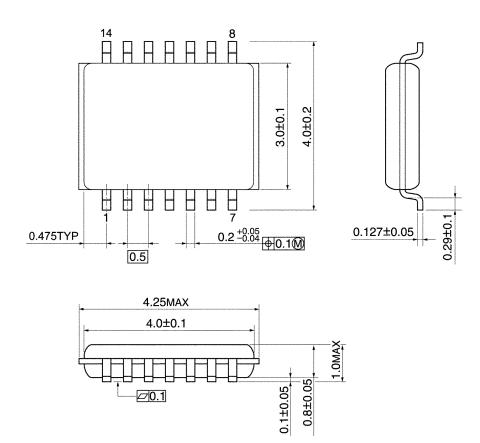
Weight: 0.06 g (typ.)

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### **Package Dimensions**

VSSOP14-P-0030-0.50

Unit: mm



Weight: 0.02 g (typ.)

### Package Dimensions

VQON16-P-0303-0.50

♦ 0.15 S A 2.7 ×# 0.15 i 2.7 **♦** 0.15 S B 0.6 MAX ы i 0.05 S 0.3 +0.15 Ø 0,0 V 0.6 4 0.3 <sup>+0.15</sup> V Þ  $\square$ 0.3 +0.15 ٠  $\square$  $\mathbb{Z}$ +0.22 ± 0.05 ♦ 0.05 ₩ S AB 团 6 0.6

Weight: 0.013 g (typ.)

Unit: mm

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